

Features

- Excellent Package For Heat Dissipation
- High Density Cell Design For Low $R_{DS(ON)}$
- Moisture Sensitivity Level 1
- Halogen Free. "Green" Device^(Note 1)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

Maximum Ratings

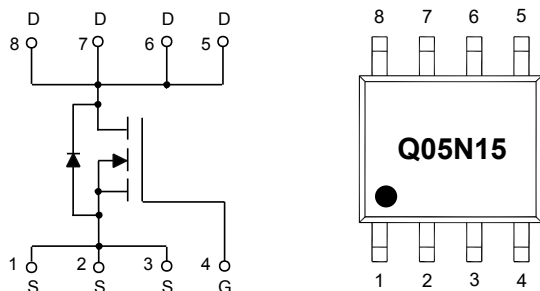
- Operating Junction Temperature Range : -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance: 62.5°C/W Junction to Ambient^(Note 2)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	150	V
Gate-Source Voltage	V_{GS}	±25	V
Continuous Drain Current	I_D	$T_A=25^\circ\text{C}$	5
		$T_A=100^\circ\text{C}$	3.2
Pulsed Drain Current ^(Note 3)	I_{DM}	20	A
Total Power Dissipation ^(Note 4)	P_D	2	W
Single Pulsed Avalanche Energy ^(Note 5)	E_{AS}	40	mJ

Note:

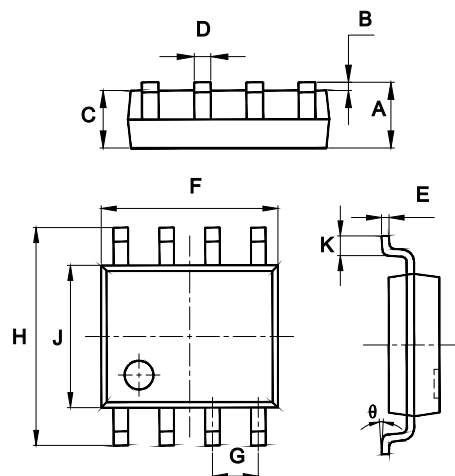
1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
2. The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ\text{C}$.
3. Repetitive rating; pulse width limited by max. junction temperature.
4. P_D is based on max. junction temperature, using junction-ambient thermal resistance.
5. $T_J=25^\circ\text{C}$, $V_{DD}=50\text{V}$, $V_{GS}=10\text{V}$, $L=0.5\text{mH}$.

Internal Structure and Marking Code



N-CHANNEL MOSFET

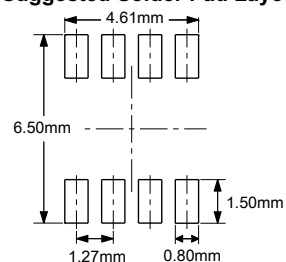
SOP-8



DIMENSIONS

DIM	INCHES		MM		NOTE
	MIN	MAX	MIN	MAX	
A	0.053	0.069	1.35	1.75	
B	0.004	0.010	0.10	0.25	
C	0.053	0.061	1.35	1.55	
D	0.013	0.020	0.33	0.51	
E	0.007	0.010	0.17	0.25	
F	0.185	0.200	4.70	5.10	
G	0.050		1.270		TYP.
H	0.228	0.244	5.80	6.20	
J	0.150	0.157	3.80	4.00	
K	0.016	0.050	0.40	1.27	
θ	0°	8°	0°	8°	

Suggested Solder Pad Layout



Electrical Characteristics @ 25°C (Unless Otherwise Specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=250\mu A$	150			V
Gate-Source Leakage Current	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 25V$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=120V, V_{GS}=0V$			1	μA
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2	3	4	V
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=3A$		51	63	m Ω
		$V_{GS}=6V, I_D=2A$		53	67	
Gate Resistance	R_g	f=1 MHz, Open drain		0.8		Ω
Diode Characteristics						
Continuous Body Diode Current	I_S				5	A
Diode Forward Voltage	V_{SD}	$V_{GS}=0V, I_S=3A$			1.3	V
Reverse Recovery Time	t_{rr}	$I_F=3A, dI_F/dt=100A/\mu s$		85		ns
Reverse Recovery Charge	Q_{rr}			427		nC
Dynamic Characteristics						
Input Capacitance	C_{iss}	$V_{DS}=75V, V_{GS}=0V, f=1MHz$		1102		pF
Output Capacitance	C_{oss}			80		
Reverse Transfer Capacitance	C_{riss}			6.1		
Total Gate Charge	Q_g	$V_{DS}=75V, V_{GS}=10V, I_D=3A$		21		nC
Gate-Source Charge	Q_{gs}			4		
Gate-Drain Charge	Q_{gd}			7.1		
Turn-On Delay Time	$t_{d(on)}$	$V_{DD}=75V, V_{GS}=10V, I_{DS}=3A, R_G=4.5\Omega$		9.1		ns
Turn-On Rise Time	t_r			4.8		
Turn-Off Delay Time	$t_{d(off)}$			20		
Turn-Off Fall Time	t_f			10		

Curve Characteristics

Fig. 1 - Typical Output Characteristics

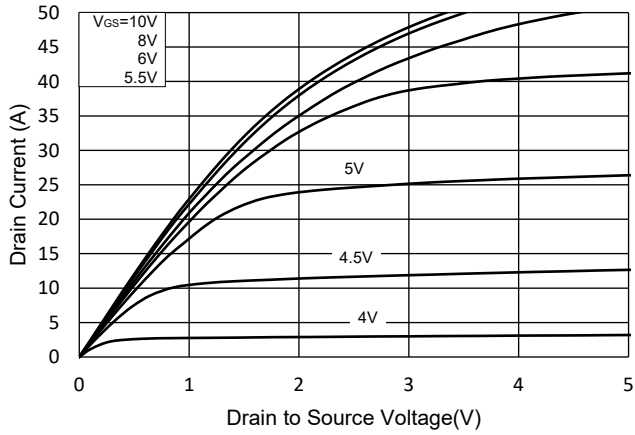


Fig.2 Transfer Characteristic

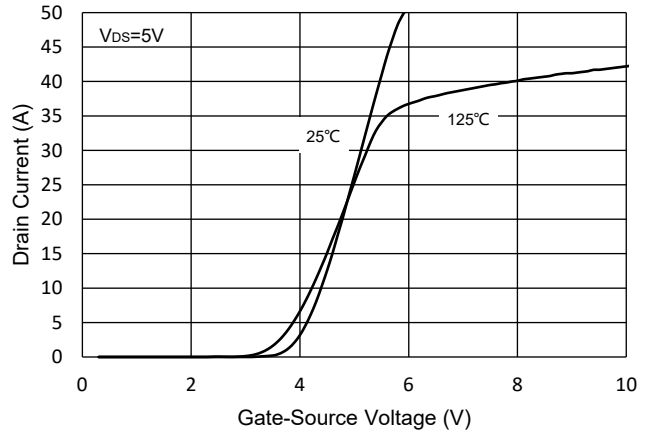


Fig.3 $R_{DS(on)}$ - V_{GS}

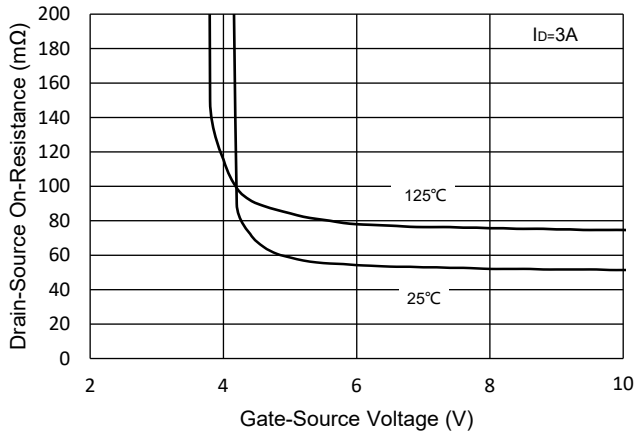


Fig. 4 - $R_{DS(on)}$ - I_D

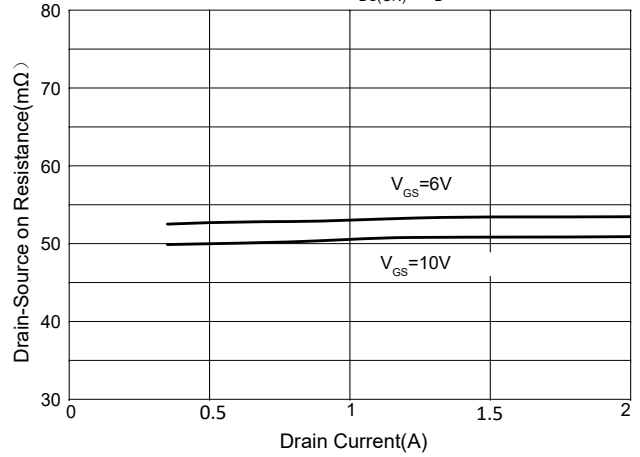


Fig.5 Capacitance Characteristics

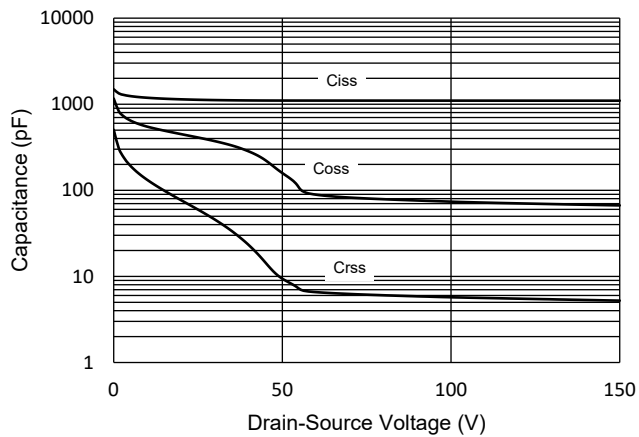
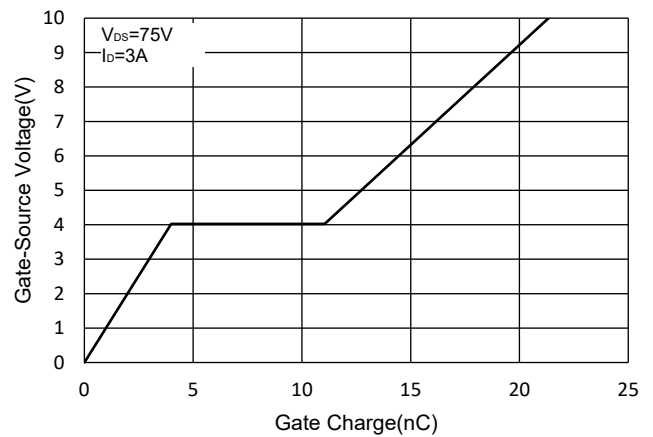
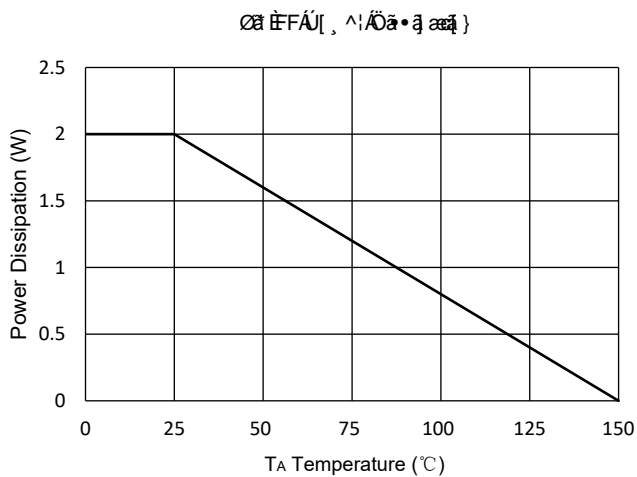
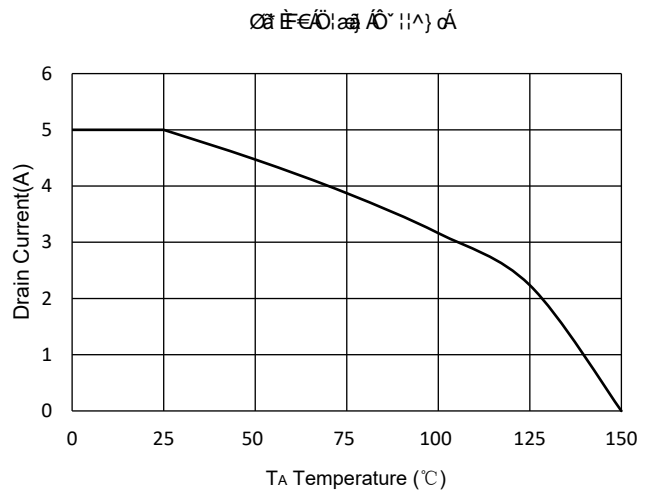
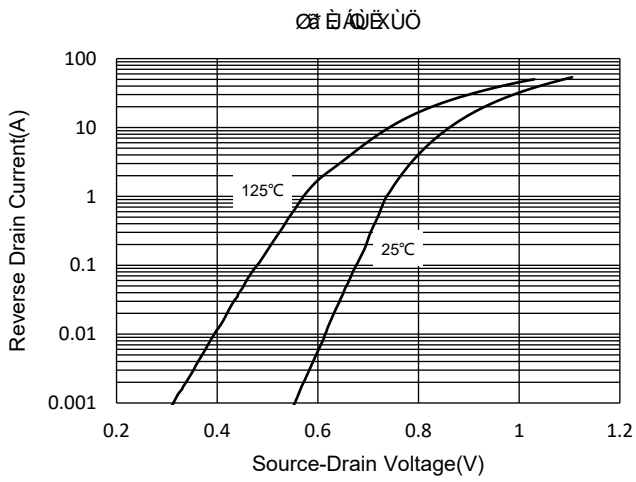
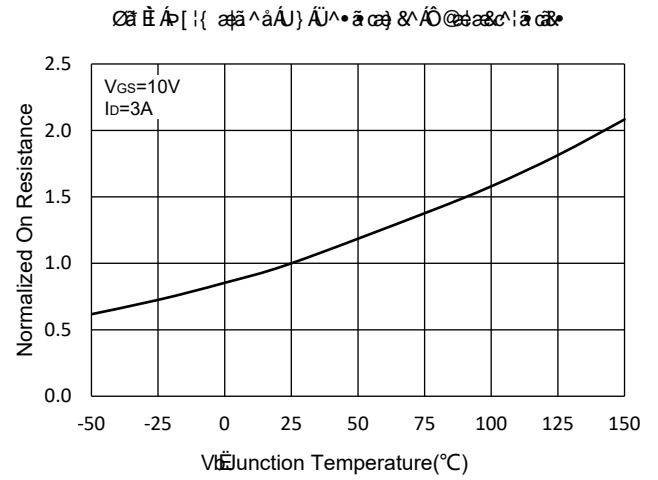
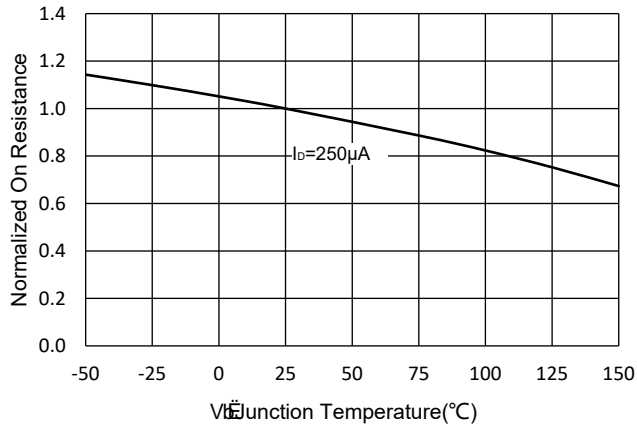


Fig.6 Gate Charge



Curve Characteristics

Fig.7 Normalized Threshold Voltage



Curve Characteristics

Fig.12 Safe Operation Area

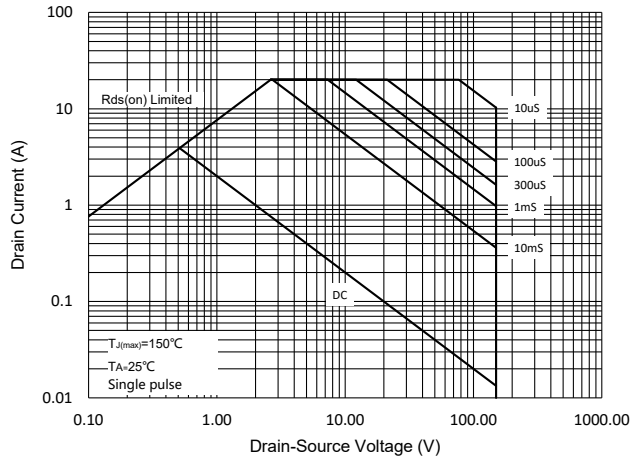
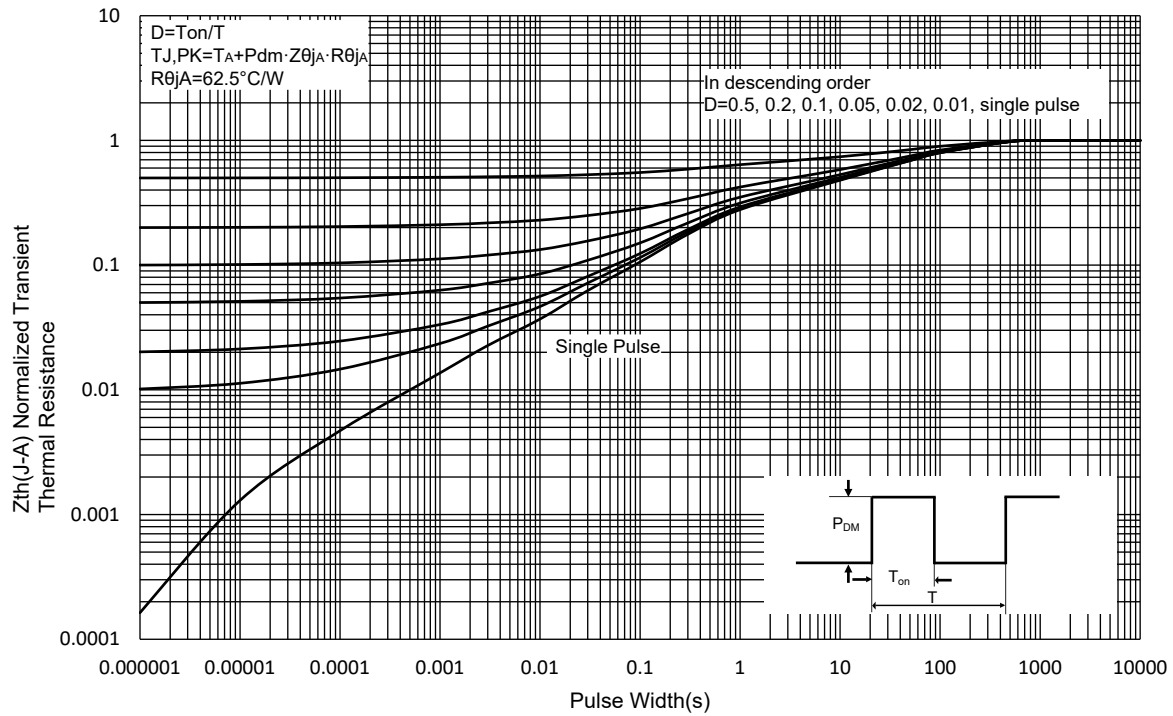


Fig.13 Normalized Transient Thermal Impedance



Ordering Information

Device	Packing
Part Number-TP	Tape&Reel: 4Kpcs/Reel

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